

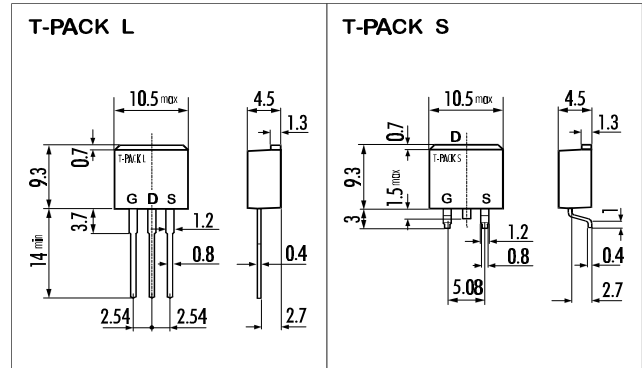
> Features

- High Current
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Forward Transconductance

> Applications

- Motor Control
- General Purpose Power Amplifier
- DC-DC converters

> Outline Drawing

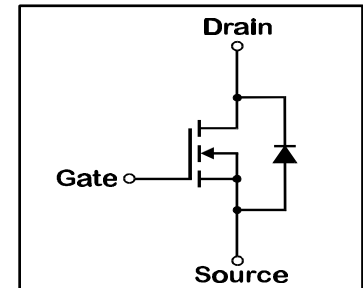


> Maximum Ratings and Characteristics

- Absolute Maximum Ratings (TC=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V_{DS}	30	V
Drain-Gate-Voltage ($R_{GS}=20K\Omega$)	V_{DGR}	30	V
Continuous Drain Current	I_D	50	A
Pulsed Drain Current	$I_{D(puls)}$	200	A
Gate-Source-Voltage	V_{GS}	± 16	V
Max. Power Dissipation	P_D	80	W
Operating and Storage Temperature Range	T_{ch}	150	°C
	T_{stg}	-55 ~ +150	°C

> Equivalent Circuit



- Electrical Characteristics (TC=25°C), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	$V_{(BR)DSS}$	$I_D=1mA$ $V_{GS}=0V$	30			V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D=1mA$ $V_{DS}=V_{GS}$	1,0	1,5	2,0	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30V$ $T_{ch}=25^\circ C$		10	500	μA
		$V_{GS}=0V$ $T_{ch}=125^\circ C$		0,2	1,0	mA
Gate Source Leakage Current	I_{GSS}	$V_{GS}=\pm 16V$ $V_{DS}=0V$		10	100	nA
Drain Source On-State Resistance	$R_{DS(on)}$	$I_D=25A$ $V_{GS}=4V$		16	22	mΩ
		$I_D=25A$ $V_{GS}=10V$		10	13	mΩ
Forward Transconductance	g_{fs}	$I_D=25A$ $V_{DS}=12V$	17	35		S
Input Capacitance	C_{iss}	$V_{DS}=25V$		3500	5250	pF
Output Capacitance	C_{oss}	$V_{GS}=0V$		1650	2480	pF
Reverse Transfer Capacitance	C_{rss}	$f=1MHz$		830	1250	pF
Turn-On-Time t_{on} ($t_{on}=t_{d(on)}+t_r$)	$t_{d(on)}$	$V_{CC}=12V$		15	25	ns
	t_r	$I_D=50A$		65	100	ns
Turn-Off-Time t_{off} ($t_{off}=t_{d(off)}+t_f$)	$t_{d(off)}$	$V_{GS}=10V$		190	290	ns
	t_f	$R_{GS}=10\Omega$		140	210	ns
Avalanche capability	I_{AV}	$L=100\mu H$ $T_{ch}=25^\circ C$	50			A
Diode Forward On-Voltage	V_{SD}	$I_F=2I_{DR}$ $V_{GS}=0V$ $T_{ch}=25^\circ C$		1,25	1,80	V
Reverse Recovery Time	t_{rr}	$I_F=I_{DR}$ $V_{GS}=0V$		60		ns
Reverse Recovery Charge	Q_{rr}	$-di_F/dt=100A/\mu s$ $T_{ch}=25^\circ C$		70		μC

- Thermal Characteristics

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	$R_{th(ch-a)}$	channel to air			125	°C/W
	$R_{th(ch-c)}$	channel to case			1,56	°C/W

N-channel MOS-FET			
30V	13 $\mu\Omega$	50A	80W

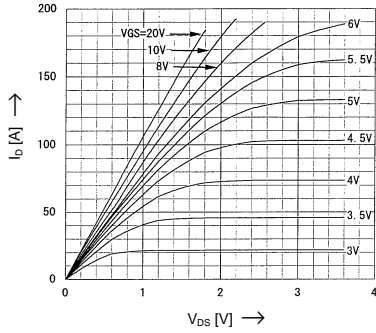
2SK2516-01L,S

FAP-III Series

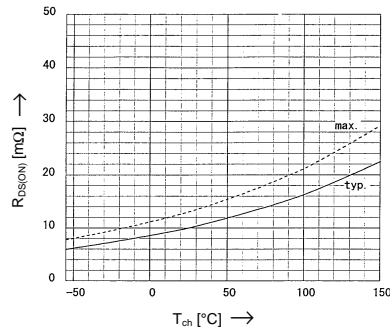


> Characteristics

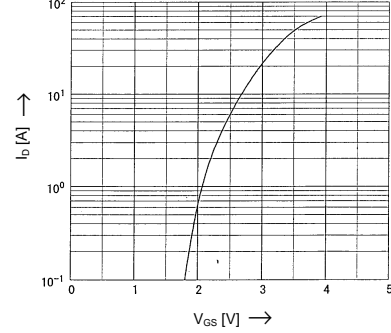
Typical Output Characteristics
 $I_D = f(V_{DS})$; 80 μ s pulse test; $T_C = 25^\circ\text{C}$



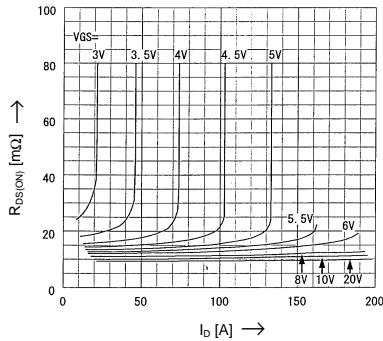
Drain-Source On-State Resistance
 $R_{DS(on)} = f(T_{ch})$; $I_D = 25\text{A}$; $V_{GS} = 10\text{V}$



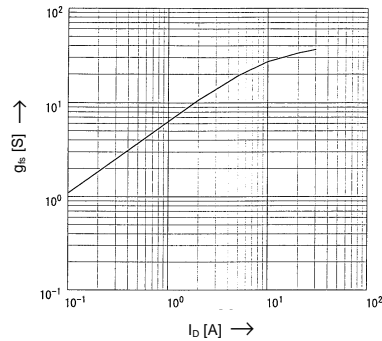
Typical Transfer Characteristics
 $I_D = f(V_{GS})$; 80 μ s pulse test; $V_{DS} = 25\text{V}$; $T_{ch} = 25^\circ\text{C}$



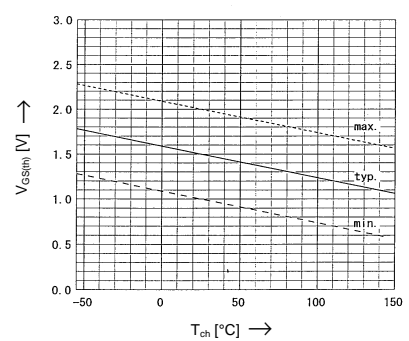
Typical Drain-Source On-State-Resistance
 $R_{DS(on)} = f(I_D)$; 80 μ s pulse test; $T_C = 25^\circ\text{C}$



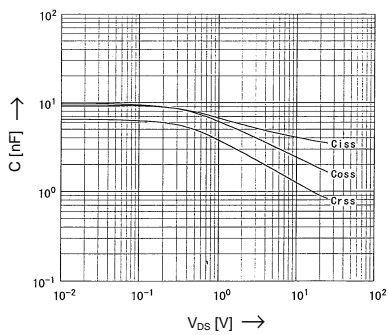
Typical Forward Transconductance
 $g_{fs} = f(I_D)$; 80 μ s pulse test; $V_{DS} = 25\text{V}$; $T_{ch} = 25^\circ\text{C}$



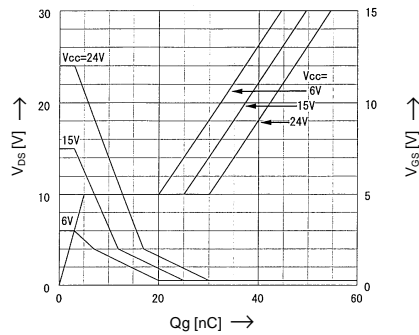
Gate Threshold Voltage vs. T_{ch}
 $V_{GS(th)} = f(T_{ch})$; $I_D = 1\text{mA}$; $V_{DS} = V_{GS}$



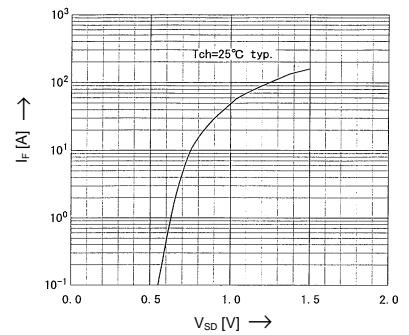
Typical Capacitances
 $C = f(V_{DS})$; $V_{GS} = 0\text{V}$; $f = 1\text{MHz}$



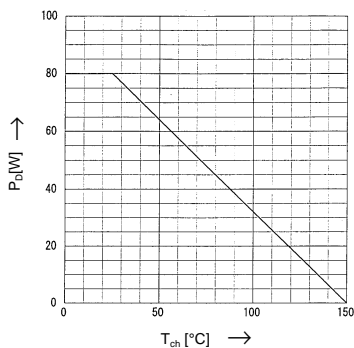
Typical Gate Charge Characteristics
 $V_{GS} = f(Q_g)$; $I_D = 50\text{A}$; $T_C = 25^\circ\text{C}$



Forward Characteristics of Reverse Diode
 $I_F = f(V_{SD})$; 80 μ s pulse test; $V_{GS} = 0\text{V}$



Power Dissipation
 $P_D = f(T_C)$



Safe Operation Area
 $I_D = f(V_{DS})$; $D = 0.01$; $T_C = 25^\circ\text{C}$

